

This listing of claims will replace all prior versions, and listings, of claims in the application:

**Listing of Claims:**

1-18 (cancelled)

1 19. (original): A thin film device comprising:  
2 at least one thin film layer;  
3 at least one electrochemically plated component; said component being formed with an  
4 overplated head that includes overhang portions;  
5 hard baked photoresist being disposed beneath said overhang portions to fill an area  
6 beneath said overhang portions.

1 20. (currently amended): A thin film device as described in claim 19 wherein said ~~metallie~~  
2 component is formed by electrochemically plating into an opening formed in a photoresist layer  
3 using photolithographic process techniques.

1 21. (original): A thin film device as described in claim 19 wherein said device is a thin film  
2 magnetic head.

1 22. (original): A thin film device as described in claim 21 wherein said component is a yoke  
2 portion of a magnetic pole.

1 23. (currently amended): A thin film device as described in claim 22 wherein said yoke  
2 portion is formed with straight sided pole tip portions and overplated yoke portions.

1 24. (original): A thin film device as described in claim 19 wherein said component is an  
2 electrical interconnecting stud.

1 25. (original): A hard disk drive, comprising:  
2 at least one hard disk being adapted for rotary motion upon a drive device;  
3 at least one slider device having a slider body portion being adapted to fly over said hard  
4 disk; a magnetic head being formed on slider body for writing data on said hard disk; said  
5 magnetic head including:  
6 at least one thin film layer;  
7 at least one electrochemically plated component; said component being formed with an  
8 overplated head that includes overhang portions;  
9 hard baked photoresist being disposed beneath said overhang portions to fill an area  
10 beneath said overhang portions.

1 26. (currently amended): A hard disk drive as described in claim 25 wherein said ~~metallie~~  
2 component is formed by electrochemically plating into an opening formed in a photoresist layer  
3 using photolithographic process techniques.

1 27. (original): A hard disk drive as described in claim 25 wherein said device is a thin film  
2 magnetic head.

1 28. (original): A hard disk drive as described in claim 27 wherein said component is a yoke  
2 portion of a magnetic pole.

1 29. (currently amended): A hard disk drive as described in claim 28 wherein said yoke  
2 portion is formed with straight sided pole tip portions and overplated yoke portions.

1 30. (original): A hard disk drive as described in claim 25 wherein said component is an  
2 electrical interconnecting stud.